



BAS70WQ /-04Q /-05Q /-06Q

SURFACE MOUNT SCHOTTKY BARRIER DIODE

Product Summary

V _{RRM} (V)	l _O (mA)	V _{F(MAX)} @ 1mA (V)	I _{R(MAX)} @ V _R = 50V (μΑ)
70	70	0.41	0.1

Applications

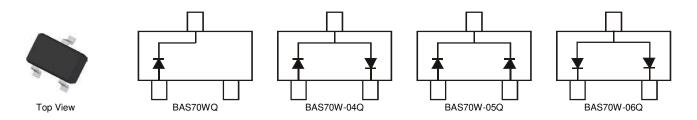
- SMPS
- DC-DC Converter
- Freewheeling Diodes
- Reverse Polarity Protection
- Blocking Diodes

Features and Benefits

- Low Turn-on Voltage
- Fast Switching
- PN Junction Guard Ring for Transient and ESD Protection
- Ultra-Small Surface Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Lead Free Plating (Matte Tin Finish Annealed over Alloy 42 Leadframe), Solderable per MIL-STD-202, Method 208 (3)
 Polarity Sao Discreme Polour
- Polarity: See Diagrams Below
- Weight: 0.006 grams (Approximate)



Ordering Information (Note 5)

Part Number	Case	Packaging
BAS70WQ-7-F	SOT323	3000/Tape & Reel
BAS70W-04Q-7-F	SOT323	3000/Tape & Reel
BAS70W-05Q-7-F	SOT323	3000/Tape & Reel
BAS70W-06Q-7-F	SOT323	3000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

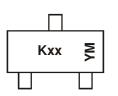
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



Kxx = Product Type Marking Code K73 = BAS70WQ K74 = BAS70W-04Q K75 = BAS70W-05Q K76 = BAS70W-06Q YM = Date Code Marking Y = Year (ex: D = 2016) M = Month (ex: 9 = September)

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Year	2010	2011	2012	2013	2014	2015	2016	2017	2018	2019	2020	2021	2022	2023
Code	Х	Y	Z	А	В	С	D	E	F	G	Н		J	K
Month	Jan	Feb	Ма	ar /	Apr	Мау	Jun	Jul	Aug	Se	р (Oct	Νον	Dec
Code	1	2	3		4	5	6	7	8	Q		0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} VR	70	V
RMS Reverse Voltage	V _{R(RMS)}	49	V
Forward Continuous Current (Note 6)	lo	70	mA
Non-Repetitive Peak Forward Surge Current @ tp < 1.0s	I _{FSM}	100	mA

Thermal Characteristics

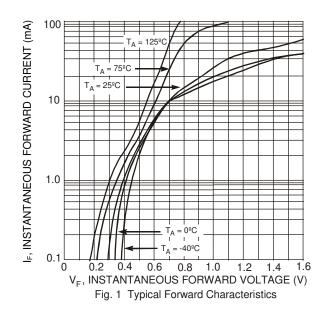
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	200	mW
Thermal Resistance Junction to Ambient Air (Note 6)	R _{0JA}	625	°C/W
Operating Temperature Range	TJ	-55 to +125	°C
Storage Temperature Range	T _{STG}	-65 to +150	О°

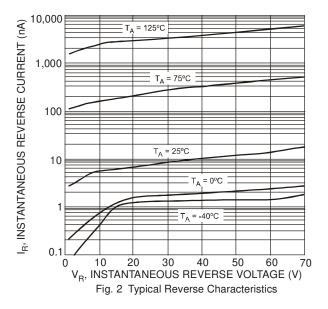
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	70	_	_	I _R = 10μA
Forward Voltage	VF	—	410 1000	mV	t _p < 300μs, I _F = 1.0mA t _p < 300μs, I _F = 15mA
Reverse Current (Note 7)	I _R	_	100	nA	$t_p < 300 \mu s, V_R = 50 V$
Total Capacitance	Ст		2.0	pF	$V_{R} = 0V, f = 1.0MHz$
Reverse Recovery Time		—	5.0	ns	$I_F = I_R = 10$ mA to $I_R = 1.0$ mA, $I_{RR} = 0.1 \times I_R$, $R_L = 100\Omega$

 Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at http://www.diodes.com/package-outlines.html.

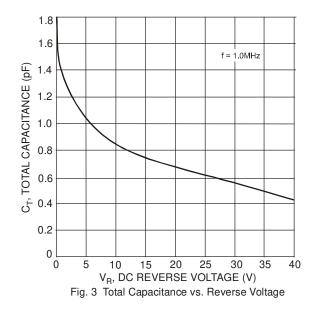
7. Short duration pulse test used to minimize self-heating effect.

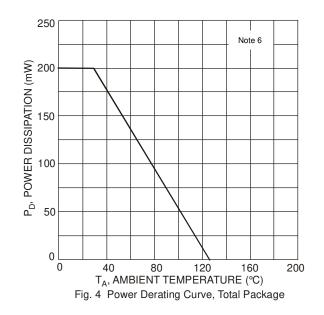










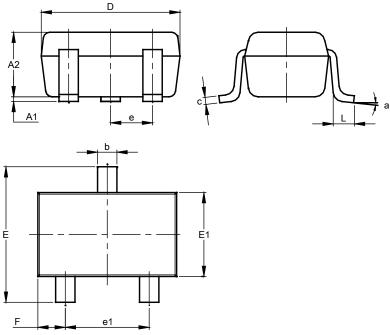




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

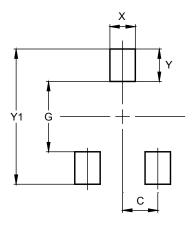
SOT323



SOT323							
Dim	Min	Max	Тур				
A1	0.00	0.10	0.05				
A2	0.90	1.00	0.95				
b	0.25	0.40	0.30				
С	0.10	0.18	0.11				
D	1.80	2.20	2.15				
Е	2.00	2.20	2.10				
E1	1.15	1.35	1.30				
е	C	0.650 B	SC				
e1	1.20	1.40	1.30				
F	0.375	0.475	0.425				
L	0.25	0.40	0.30				
а	0°	8°					
All	Dimen	sions i	in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT323

Dimensions	Value (in mm)
С	0.650
G	1.300
Х	0.470
Y	0.600
Y1	2.500



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